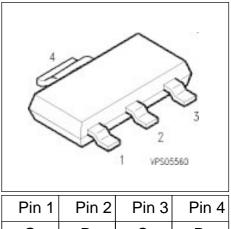
### SIPMOS® Small-Signal Transistor

- N channel
- Enhancement mode
- Avalanche rated
- V<sub>GS(th)</sub>= 2.1 ... 4.0 V



Pin 1	Pin 2	Pin 3	Pin 4
G	D	S	D

Туре	V <sub>DS</sub>	I <sub>D</sub>	R <sub>DS(on)</sub>	Package	Marking
BSP 299	500 V	0.4 A	4 Ω	SOT-223	BSP 299

Туре	Ordering Code	Tape and Reel Information
BSP 299	Q67000-S225	E6327

### **Maximum Ratings**

Parameter	Symbol	Values	Unit
Continuous drain current	I <sub>D</sub>		А
<i>T</i> <sub>A</sub> = 44 °C		0.4	
DC drain current, pulsed	I <sub>Dpuls</sub>		
<i>T</i> <sub>A</sub> = 25 °C		1.6	
Avalanche energy, single pulse	E <sub>AS</sub>		mJ
$I_{\rm D} = 1.2 \; {\rm A}, \; V_{\rm DD} = 50 \; {\rm V}, \; R_{\rm GS} = 25 \; {\rm \Omega}$			
$L = 163 \text{ mH}, T_j = 25 \text{ °C}$		130	
Gate source voltage	$V_{GS}$	± 20	V
Power dissipation	P <sub>tot</sub>		W
<i>T</i> <sub>A</sub> = 25 °C		1.8	

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### **Maximum Ratings**

Parameter	Symbol	Values	Unit	
Chip or operating temperature	$T_{\rm j}$	-55 <b>+</b> 150	°C	
Storage temperature	T <sub>stg</sub>	-55 <b>+</b> 150		
Thermal resistance, chip to ambient air	$R_{thJA}$	≤ 70	K/W	
Therminal resistance, junction-soldering point 1)	R <sub>thJS</sub>	≤ 10	1	
DIN humidity category, DIN 40 040		E		
IEC climatic category, DIN IEC 68-1		55 / 150 / 56		

<sup>1)</sup> Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm<sup>2</sup> copper area for drain connection

### **Electrical Characteristics,** at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain- source breakdown voltage	V <sub>(BR)DSS</sub>				V
$V_{\rm GS} = 0 \text{ V}, I_{\rm D} = 0.25 \text{ mA}, T_{\rm j} = 0 ^{\circ}\text{C}$		500	-	-	
Gate threshold voltage	V <sub>GS(th)</sub>				
$V_{\text{GS}} = V_{\text{DS}}$ , $I_{\text{D}} = 1 \text{ mA}$		2.1	3	4	
Zero gate voltage drain current	I <sub>DSS</sub>				μΑ
$V_{\rm DS} = 500 \; \rm V, \; V_{\rm GS} = 0 \; \rm V, \; T_{\rm j} = 25 \; ^{\circ}\rm C$		-	0.1	1	
$V_{\rm DS} = 500 \; \rm V, \; V_{\rm GS} = 0 \; \rm V, \; T_{\rm j} = 125 \; ^{\circ} \rm C$		-	10	100	
Gate-source leakage current	I <sub>GSS</sub>				nA
$V_{GS} = 20 \text{ V}, \ V_{DS} = 0 \text{ V}$		-	10	100	
Drain-Source on-state resistance	R <sub>DS(on)</sub>				Ω
$V_{GS} = 10 \text{ V}, I_{D} = 0.4 \text{ A}$		-	3.5	4	

### **Electrical Characteristics**, at $T_j = 25$ °C, unless otherwise specified

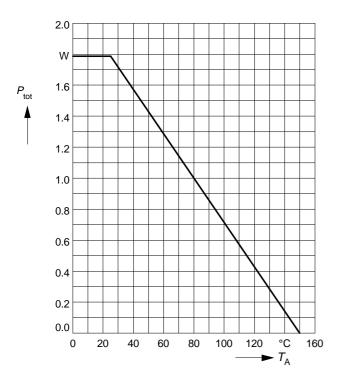
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Transconductance	$g_{fs}$				S
$V_{\rm DS} \ge 2 * I_{\rm D} * R_{\rm DS(on)max}, I_{\rm D} = 0.4 \text{ A}$		0.3	1.2	-	
Input capacitance	C <sub>iss</sub>				pF
$V_{GS} = 0 \text{ V}, \ V_{DS} = 25 \text{ V}, \ f = 1 \text{ MHz}$		-	300	400	
Output capacitance	Coss				
$V_{GS} = 0 \text{ V}, \ V_{DS} = 25 \text{ V}, \ f = 1 \text{ MHz}$		-	40	60	
Reverse transfer capacitance	C <sub>rss</sub>				
$V_{GS} = 0 \text{ V}, \ V_{DS} = 25 \text{ V}, \ f = 1 \text{ MHz}$		-	15	25	
Turn-on delay time	t <sub>d(on)</sub>				ns
$V_{\rm DD} = 30 \; {\rm V}, \; V_{\rm GS} = 10 \; {\rm V}, \; I_{\rm D} = 0.3 \; {\rm A}$					
$R_{\rm GS} = 50~\Omega$		-	8	12	
Rise time	t <sub>r</sub>				
$V_{\rm DD} = 30 \; {\rm V}, \; V_{\rm GS} = 10 \; {\rm V}, \; I_{\rm D} = 0.3 \; {\rm A}$					
$R_{\rm GS} = 50~\Omega$		-	15	22	
Turn-off delay time	t <sub>d(off)</sub>				
$V_{\rm DD} = 30 \; {\rm V}, \; V_{\rm GS} = 10 \; {\rm V}, \; I_{\rm D} = 0.3 \; {\rm A}$					
$R_{\rm GS} = 50~\Omega$		-	55	70	
Fall time	t <sub>f</sub>				
$V_{\rm DD} = 30 \; {\rm V}, \; V_{\rm GS} = 10 \; {\rm V}, \; I_{\rm D} = 0.3 \; {\rm A}$					
$R_{\rm GS} = 50 \ \Omega$		-	30	40	

## **Electrical Characteristics**, at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Inverse diode continuous forward current	Is				Α
<i>T</i> <sub>A</sub> = 25 °C		-	-	0.4	
Inverse diode direct current,pulsed	I <sub>SM</sub>				
<i>T</i> <sub>A</sub> = 25 °C		-	-	1.6	
Inverse diode forward voltage	V <sub>SD</sub>				V
$V_{GS} = 0 \text{ V}, I_{F} = 0.8 \text{ A}, T_{j} = 25 ^{\circ}\text{C}$		-	0.9	1.2	
Reverse recovery time	t <sub>rr</sub>				ns
$V_{R} = 100 \text{ V}, I_{F} = I_{S}, di_{F}/dt = 100 \text{ A/}\mu\text{s}$		-	300	-	
Reverse recovery charge	Q <sub>rr</sub>				μC
$V_{R} = 100 \text{ V}, I_{F} = I_{S}, di_{F}/dt = 100 \text{ A/}\mu\text{s}$		-	2.5	-	

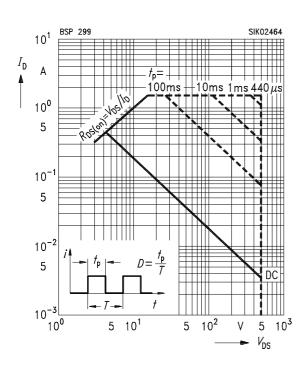
#### **Power dissipation**

$$P_{\text{tot}} = f(T_{A})$$



### Safe operating area $I_D = f(V_{DS})$

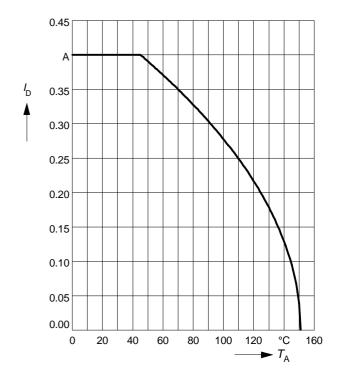
parameter : D = 0,  $T_C = 25$ °C



#### **Drain current**

 $I_{\mathsf{D}} = f(T_{\mathsf{A}})$ 

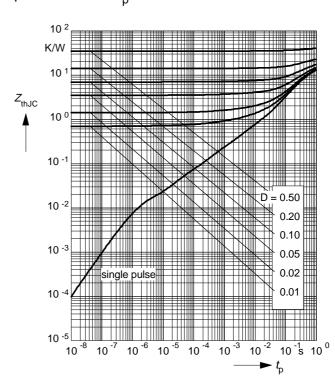
parameter: V<sub>GS</sub> ≥ 10 V



#### **Transient thermal impedance**

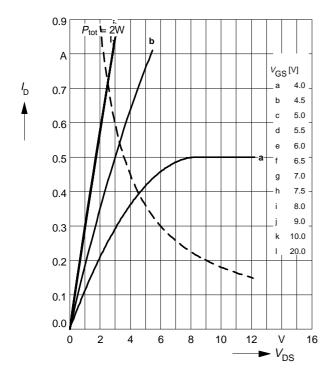
$$Z_{\text{th JA}} = f(t_{\text{p}})$$

parameter:  $D = t_p / T$ 

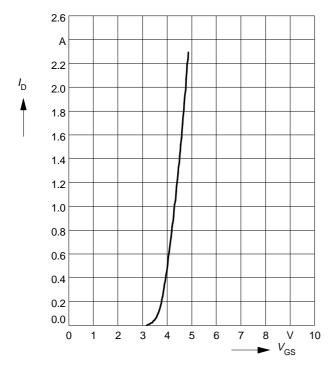


#### Typ. output characteristics

 $I_{\rm D} = f(V_{\rm DS})$  parameter:  $t_{\rm p} = 80~\mu \rm s$  ,  $T_{\rm i} = 25~{\rm ^{\circ}C}$ 

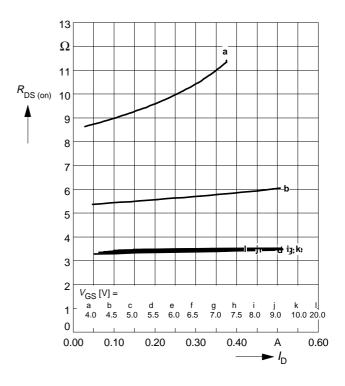


Typ. transfer characteristics  $I_D = f(V_{GS})$  parameter:  $t_p = 80 \mu s$ 

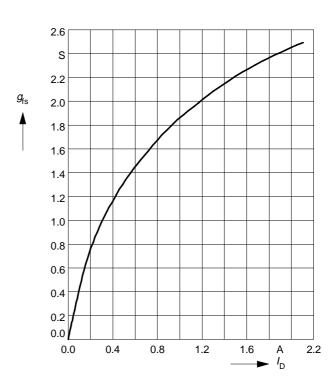


### Typ. drain-source on-resistance

 $R_{\rm DS~(on)} = f(I_{\rm D})$ parameter:  $t_{\rm p} = 80~\mu \rm s,~T_{\rm i} = 25~^{\circ} C$ 

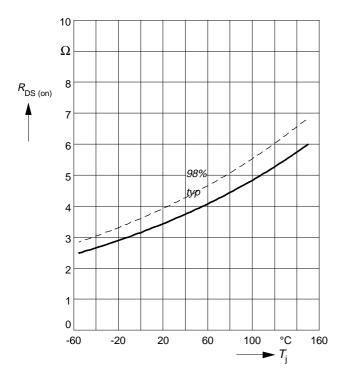


Typ. forward transconductance  $g_{fs} = f(I_D)$  parameter:  $t_p = 80 \mu s$ ,



#### **Drain-source on-resistance**

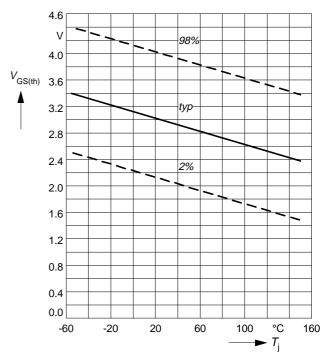
 $R_{\rm DS~(on)} = f(T_{\rm j})$  parameter:  $I_{\rm D} = 0.4$  A,  $V_{\rm GS} = 10$  V



#### Gate threshold voltage

 $V_{GS (th)} = f(T_j)$ 

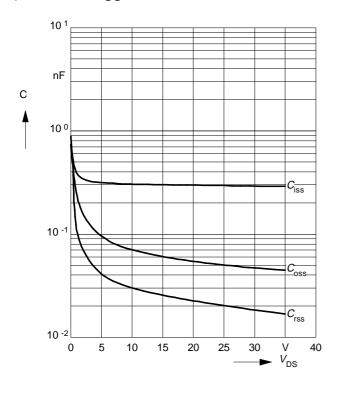
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = 1 \text{ mA}$ 



### Typ. capacitances

 $C = f(V_{DS})$ 

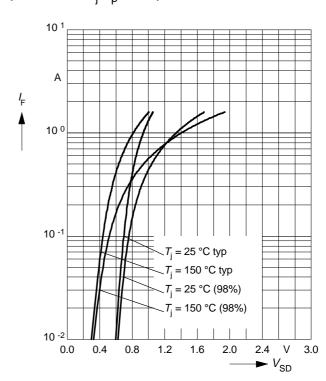
parameter:  $V_{GS}=0V$ , f=1 MHz



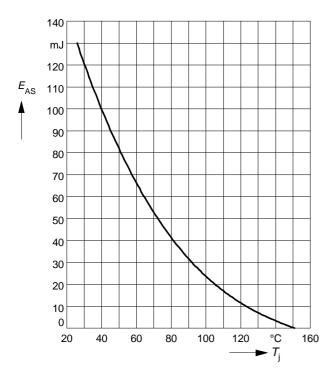
#### Forward characteristics of reverse diode

 $I_{\mathsf{F}} = f(V_{\mathsf{SD}})$ 

parameter:  $T_i$ ,  $t_p = 80 \mu s$ 

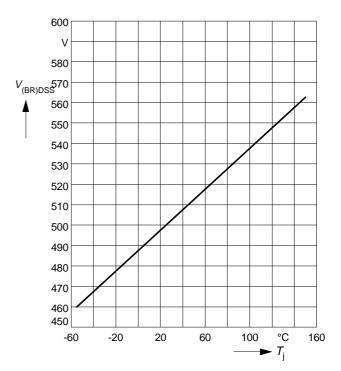


### Avalanche energy $E_{AS} = f(T_j)$ parameter: $I_D = 1.2 \text{ A}, V_{DD} = 50 \text{ V}$ $R_{GS} = 25 \Omega, L = 163 \text{ mH}$



#### Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$



### Safe operating area $I_{\rm D} = f(V_{\rm DS})$

parameter : D = 0.01,  $T_C = 25$ °C

